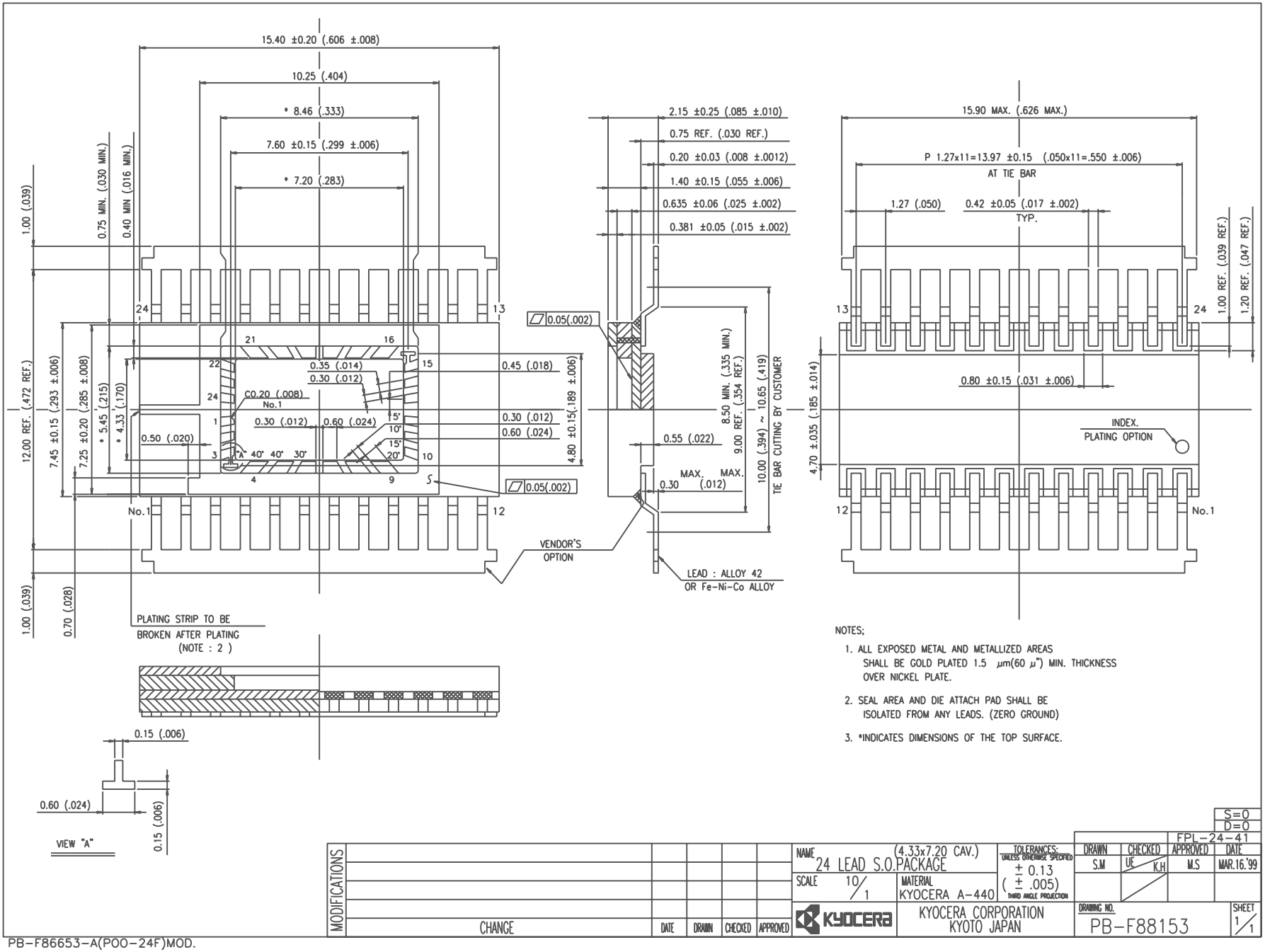
# SSM P/N CSO02404




NOTES;

1. ALL EXPOSED METAL AND METALLIZED AREAS SHALL BE GOLD PLATED 1.5 μm(60 μ") MIN. THICKNESS OVER NICKEL PLATE.
2. SEAL AREA AND DIE ATTACH PAD SHALL BE ISOLATED FROM ANY LEADS. (ZERO GROUND)
3. *INDICATES DIMENSIONS OF THE TOP SURFACE.

| MODIFICATIONS | | | | | |
|---|---|---|---|---|---|
| CHANGE | DATE | DRAWN | CHECKED | APPROVED | |

NAME: 24 LEAD S.O.PACKAGE (4.33x7.20 CAV.)
SCALE: 10/1
MATERIAL: KYOCERA A-440
TOLERANCES: UNLESS DIMENSIONS SPECIFIED ± 0.13 ( ± .005) THIRD ANGLE PROJECTION
KYOCERA
KYOCERA CORPORATION KYOTO JAPAN

S=0 D=0

FPL-24-41

| DRAWN | CHECKED | APPROVED | DATE |
|---|---|---|---|
| S.M | U.E / K.H | M.S | MAR.16.'99 |

DRAWING NO. PB-F88153
SHEET 1/1

PB-F86653-A(P00-24F)MOD.

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